

01-24-02

2800 0410 d3



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

q-232

Applicants: Tai-Peng Lee et al.
Assignee: Mosel Vitelic Corporation
Title: Reduced Thickness Variation In A Material Layer Deposited In Narrow And Wide Integrated Circuit Trenches
Serial No.: 10/033,114 Filing Date: October 22, 2001
Examiner: Not assigned yet Group Art Unit: Not assigned yet
Docket No.: M-11912 US

San Jose, California
January 18, 2002

COMMISSIONER FOR PATENTS
Washington, D.C. 20231

INFORMATION DISCLOSURE STATEMENT UNDER 37 CFR § 1.97(b)

Dear Sir:

Pursuant to 37 C.F.R. § 1.56, § 1.97 and § 1.98, the document listed on the accompanying form PTO-1449 is called to the attention of the Examiner for the above patent application. A copy of this document is enclosed.

Citation of this document shall not be construed as:

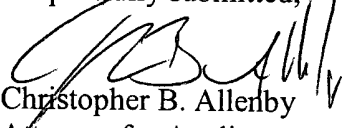
1. an admission that the document is necessarily prior art with respect to the instant invention;
2. a representation that a search has been made; or
3. an admission that the information cited herein is, or is considered to be, material to patentability as defined in § 1.56(b).

The Commissioner is hereby authorized to charge any additional fees which may be required, or credit any overpayment, to Deposit Account No. 19-2386.

EXPRESS MAIL LABEL NO:

EL 710 216 495 US

Respectfully submitted,


Christopher B. Allenby
Attorney for Applicants
Reg. No. 45,906

LAW OFFICES OF
SKJERVEN MORRILL
MacPHERSON LLP

25 METRO DRIVE
SUITE 700
SAN JOSE, CA 95110
(408) 453-9200
FAX (408) 453-7979

814082814082 v1